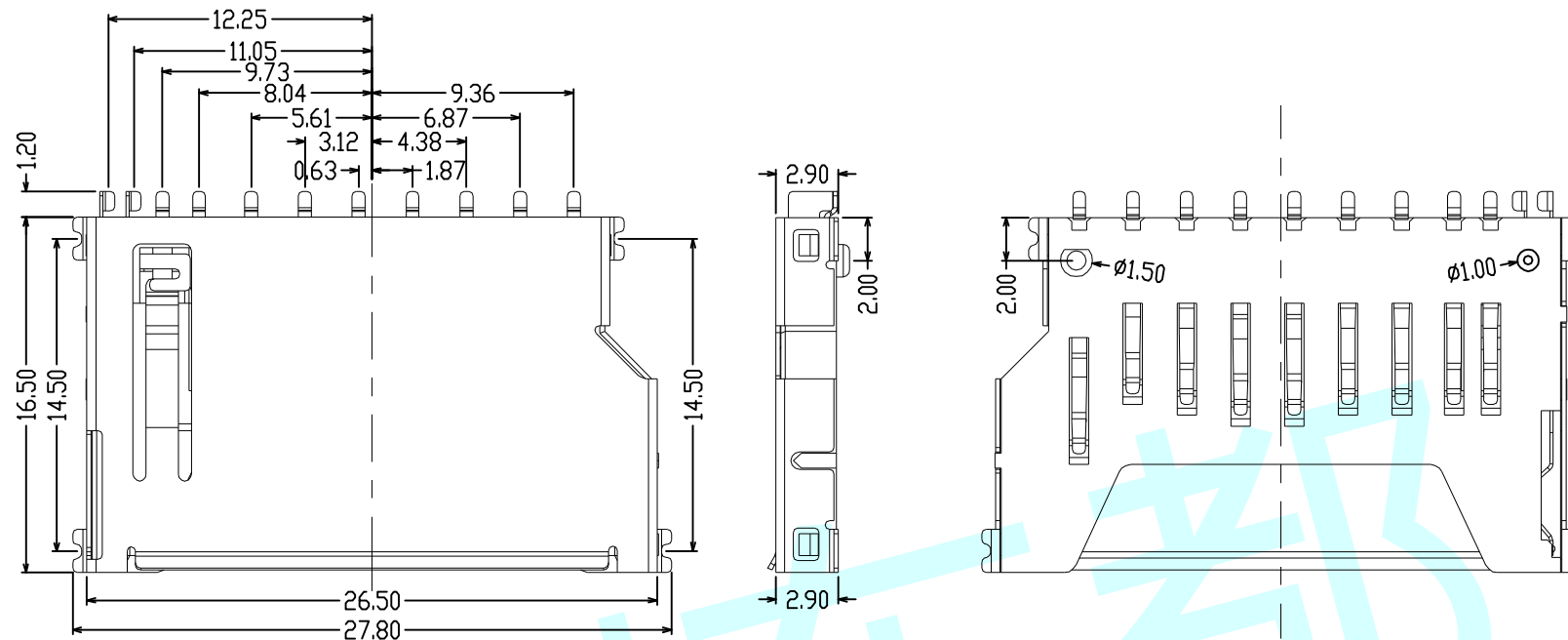
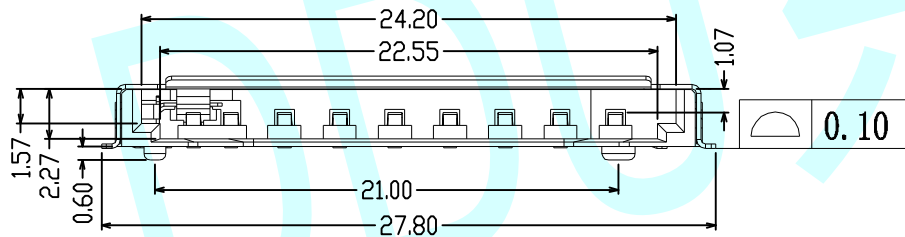


ROHS



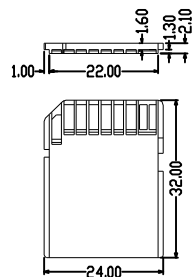
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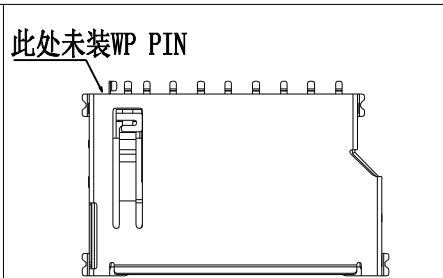
0.10

NOTES:

1. MATERIAL:
 - A. HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94 V-0, COLOR: WHITE
 - B. CONTACT: COPPER ALLOYS
 - COVER: COPPER ALLOYS
2. PLATING:
 - A. UNDERPLATE: NICKEL
 - B. CONTACT AREA: GOLD OVER NICKEL
 - C. SOLDER AREA: TIN OVER NICKEL
3. MULTIMEDIA CARD COMPATIBLE

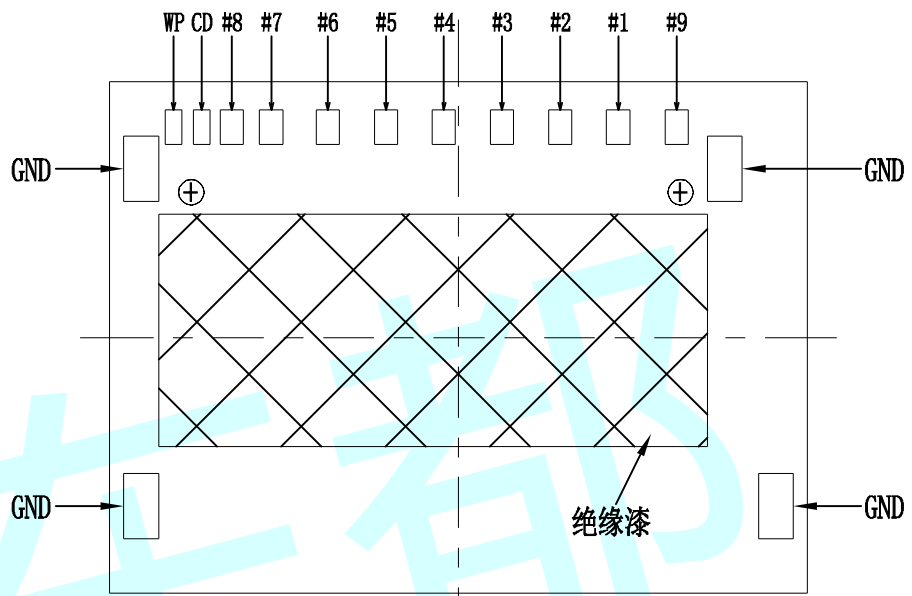
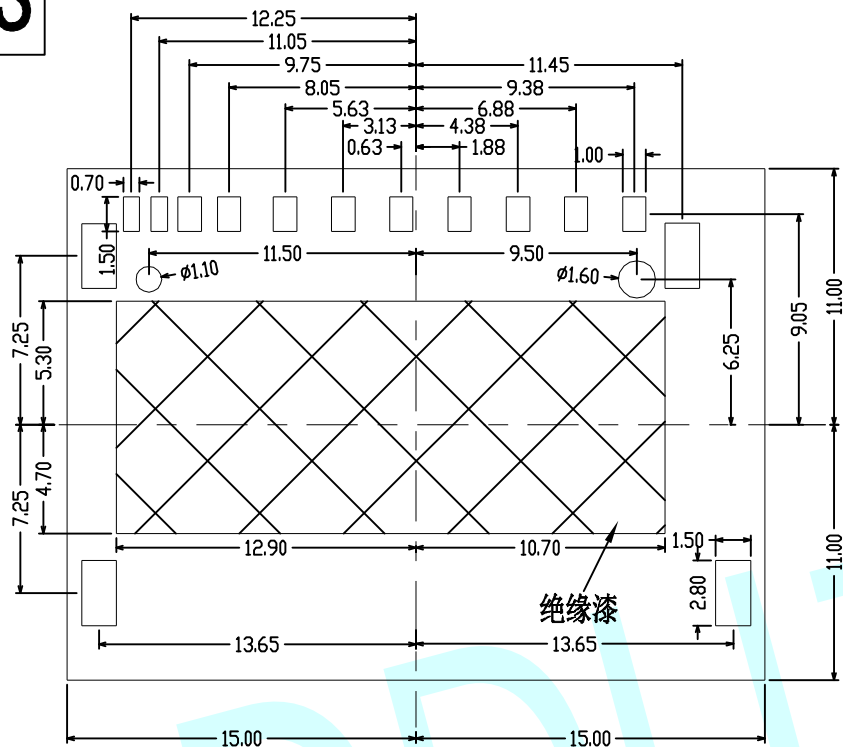


SD CARD



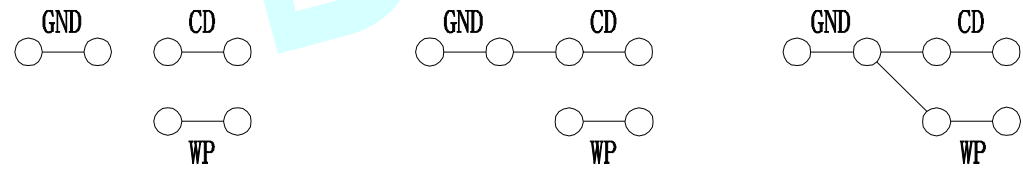
APPROVALS		DATE	http://www.dongdudz.com	
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:
CHECKED:	***	****	30 [≥]	±2°
APPOVALS:	***	****	10°30	
			5°10	
			≤5	
			东都电子 DONGDU ELECTRONICS	
			MODL:	CASSETTE
			PART NO:	SD-002
			UNIT :mm	SCALE: 1:1
			REV:	A
				PAGE: 1/2

ROHS



PCB LAYOUT
(TOLERANCE: ±0.05)


PIN NO.	NAME	DESCRIPTION
1#	CD/DAT3	CARD DETECT
2#	CMD	COMMAND
3#	VSS1	GROUND
4#	VDD	POWEER
5#	CLK	CLACK
6#	VSS2	GROUND
7#	DATO	DATE I/O
8#	DAT1	DATE I/O



WITHOUT CAED

INSERTED CAED

INSERTED CAED
WP UNLOCK

APPROVALS		DATE	http://www.dongduz.com		 东都电子 DONGDU ELECTRONICS
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:	
CHECKED:	***	****	30°	±0.30	
APPOVALS:	***	****	10°30	±0.20	
			5°10	±0.15	
			≤5	±0.10	MODBL: CASSETTE PART NO: SD-002 UNIT :mm SCALE:1:1 REV: A